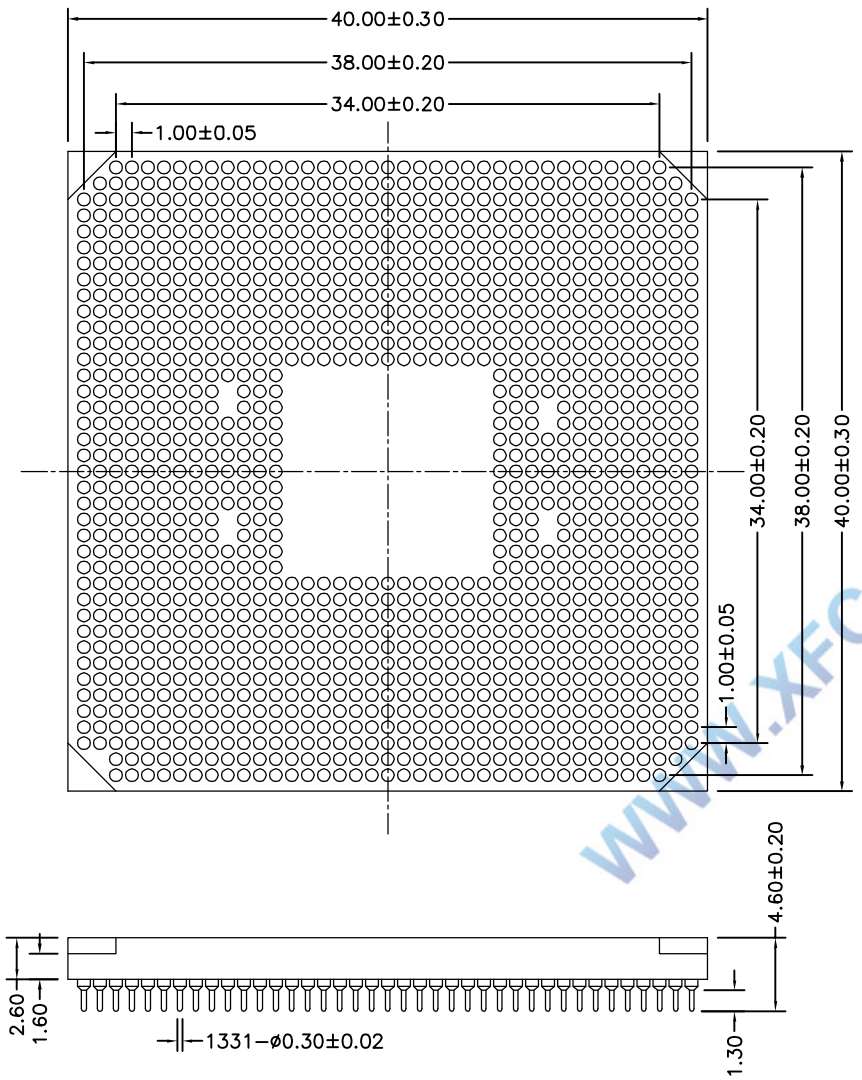
环保物料

TEL:0769-82001899



Technical Data

Materlal:

Pin(outer sleeve):Brass,machined CuZn38Pb2

Plating (Sleeve):3μ"Gold Plated over Nickel

Plating (Cllp):3μ"Gold Plated over Nickel

Insulator:FR4 UL94V-0

Cllp(Contact 3 Flnger):Beryllium copper,heat teated

Electrlcal:

Current rating:3Amps/contact max.

Contact resistance:≤4mΩ/contact

Insulation resistance:≥1KM at V=100V

Operaling voltage:60VAC/DC

Mechanical:

Average Insertion force with steel pin of ⌀0.28<30g

Average withdrawal force with steel pin of ⌀0.28:>9g

Operaling temperature:-55° C to-125° C

Soldering temperature:+260° C,10s max

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VER	MODIFICATION	DRAW	DATE
A0			

TOLERANCE UNLESS OTHERWISE

X.	±0.30	X°	±5°
.X	±0.20	.X°	±2°
.XX	±0.08	.XX°	±1°
.XXX	±0.03	.XXX°	±0.5°

DRAWN	CK tan
CHKD	
APPD	
VIEW	

XFCN兴飞连接器有限公司
CONNECTORS XFCN CONNECTORS CO., LTD.

PRODUCT NAME	Pin grid array sockets 1.00x1.00mm 1331PIN
PART. NO.	XF-P1331GG0460B

SHEET	1/1
DATE	2010.4.12
UNITS	mm
SCALE	1:1
DWG NO.	009